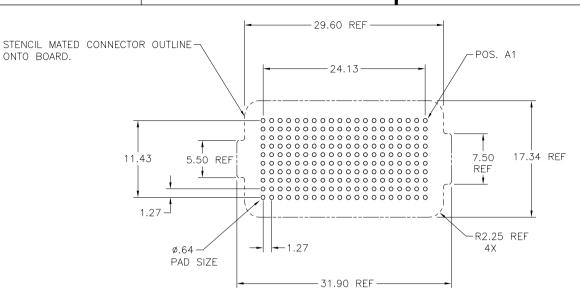


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ONTO BOARD.



NOTES:

(1.) <u>MAT'L</u>

HOUSING: LCP

CONTACT: COPPER ALLOY

**PLATING** 

CONTACT: (SEE TABLE ON SHEET1) SOLDER BALL: (SEE TABLE ON SHEET1) EUTECTIC SnPb OR LEAD FREE 95.5Sn/4Aa/0.5Cu

2. OVERALL BOARD-TO-BOARD STACK HEIGHTS AVAILABLE USING THIS CONNECTOR (84535):

MATED HEIGHT	WITH PLUG P/N
8mm	84516
14mm	84530

- (3.) PLATING FOR -2XX SERIES DASH NOS: Au OVER Ni WITH SPECIAL CONTACT GEOMETRY TO MEET REQUIREMENTS OF TELCORDIA GR-1217-CORE: CENTRAL OFFICE ENVIRONMENT.
- 4. SEE SK-47384 FOR MATING RESTRICTIONS WITH EARLIER DESIGN VERSIONS.

BOARD PATTERN

- (5) FOR PROPER APPLICATION FOLLOW FCI APPLICATION SPECIFICATION GS-20-033 LEAD FREE SOLDER BALLS WILL NOT SOLDER PROPERLY IN A LEADED SOLDER PROCESS DUE TO A HIGHER REFLOW TEMPERATURE. LEAD FREE PRODUCT IS THERFORE NOT BACKWARDS COMPATIBLE WITH LEADED OR SOME SOLDERING APPLICATIONS. REFERENCE FCI APPLICATION SPECIFICATION
- (6.) THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008 PRODUCT MEETING THIS DIRECTIVE IS IDENTIFIED IN THE LOT CODE NUMBER MARKED ON EACH PART BY HAVING AN "X" IN THE SEVENTH CHARACTER POSITION

mat'l. code					surface / toler			ance		projection		product family											
_					ASME Y14.5 V ASME				Y14.5		<b>⊕</b> <1		1	MEG-Array									
ltr	ecn no	o dr	date	2	toleran	ces u	ınless	otherw	ise sp	ecified	V	7 -	7	title									
F					angles	ngles ja			X ±.3 X ±.10		MM		_	8.0mm RECPT. ASSY.									
					0° ±2	7=	.XXX		±.050		scale	1	:1	10 X 20 = 200 POS.						S.			
					dr D.V		WAUGHEN		9.7.99	.99				dwg	по			S	heet	2 c	f 3	size	
					engr		B.SPINK		9.7.99		FCi			84535						$ _{A4} $			
					chr	Е	B.SPINK		9.7.99		( )												
					appd	Е	B.SPINK		9.7.99					type			CUSTOMER Drav					ing	
shee	et r	evision																					
inde:	x s	heet																					
									3													4	

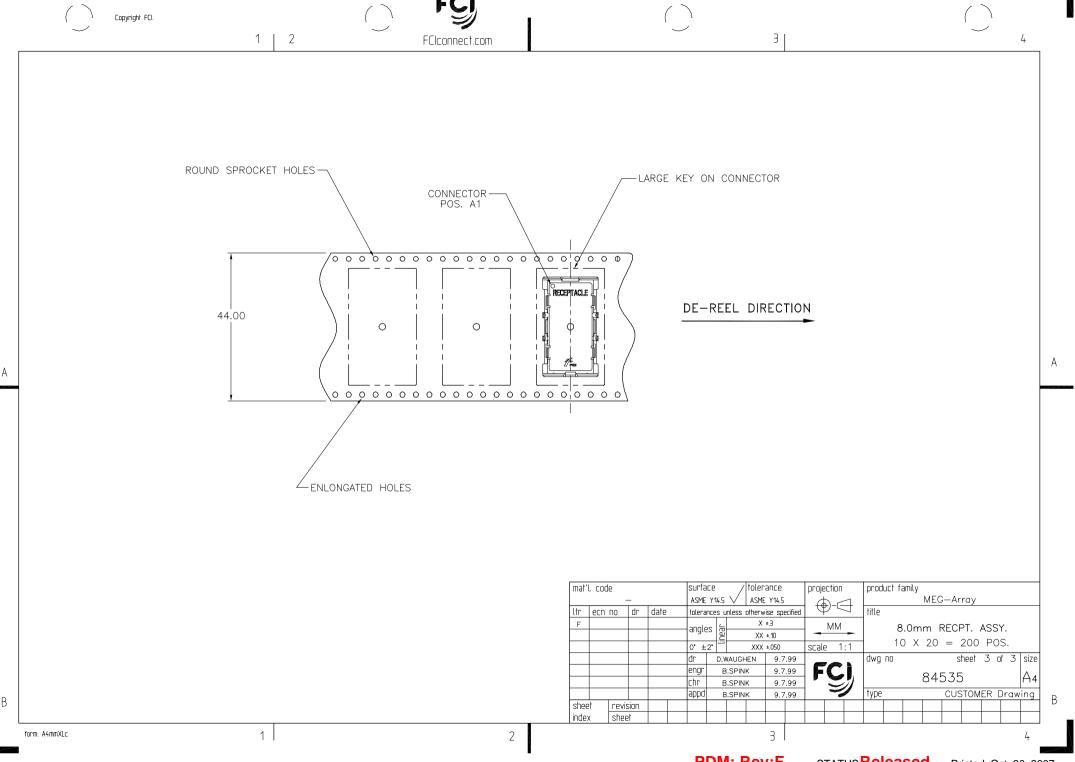
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